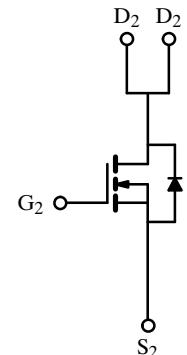
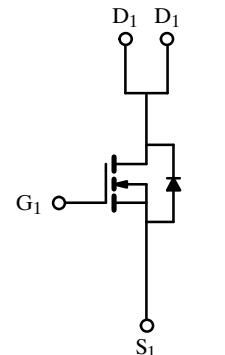
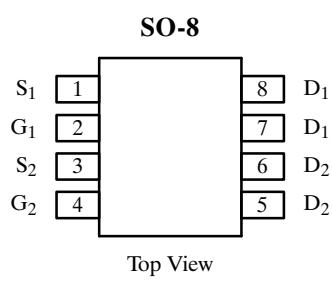


Dual N-Channel Enhancement-Mode MOSFET**Product Summary**

V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A)
20	0.05 @ V _{GS} = 4.5 V	± 5.0
	0.06 @ V _{GS} = 3.0 V	± 4.2
	0.08 @ V _{GS} = 2.5 V	± 3.6

**Absolute Maximum Ratings (T_A = 25°C Unless Otherwise Noted)**

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{GS}	± 12	
Continuous Drain Current (T _J = 150°C) ^a	I _D	± 5.0	A
		± 4.0	
Pulsed Drain Current (10 μ s Pulse Width)	I _{DM}	± 48	
Continuous Source Current (Diode Conduction) ^a	I _S	1.7	
Maximum Power Dissipation ^a	P _D	2	W
		1.3	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C

Thermal Resistance Ratings

Parameter	Symbol	Limit	Unit
Maximum Junction-to-Ambient ^a	R _{thJA}	62.5	°C/W

Notes

a. Surface Mounted on FR4 Board, t ≤ 10 sec.

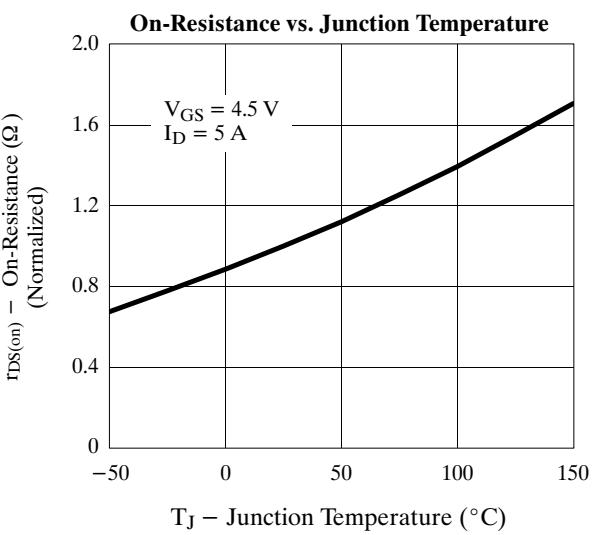
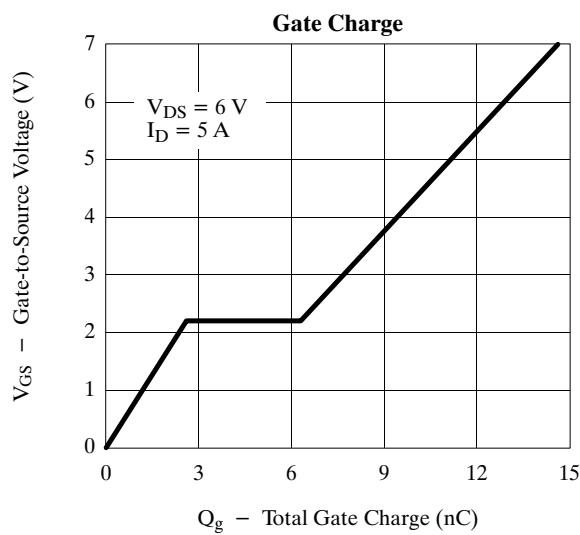
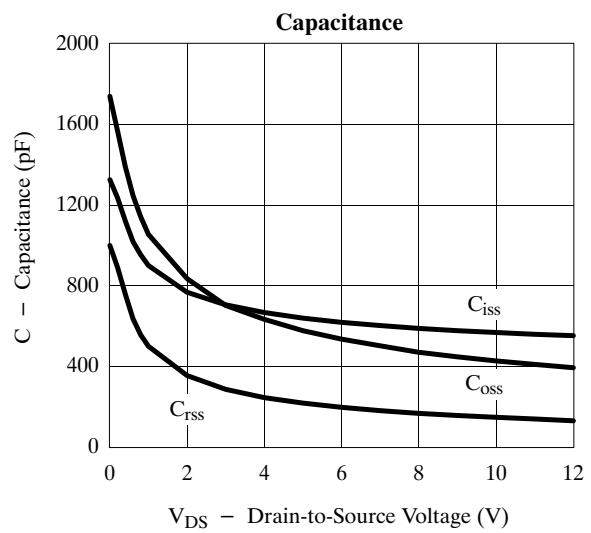
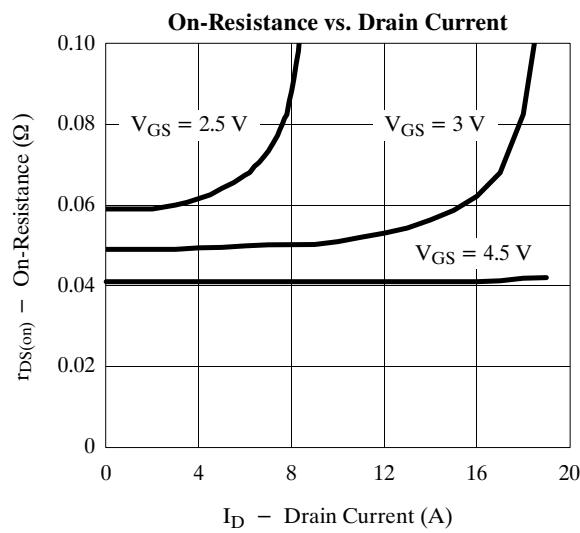
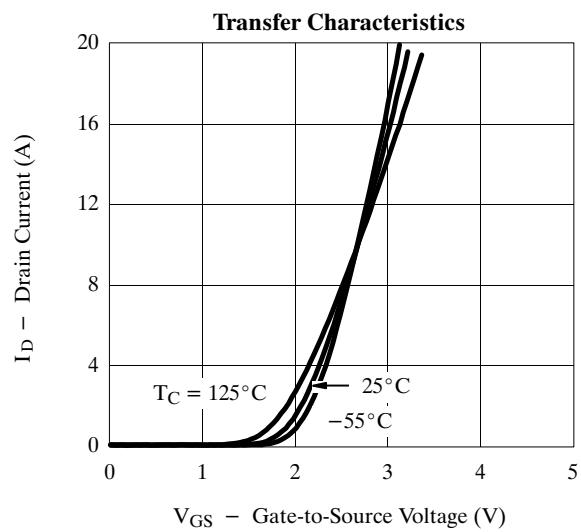
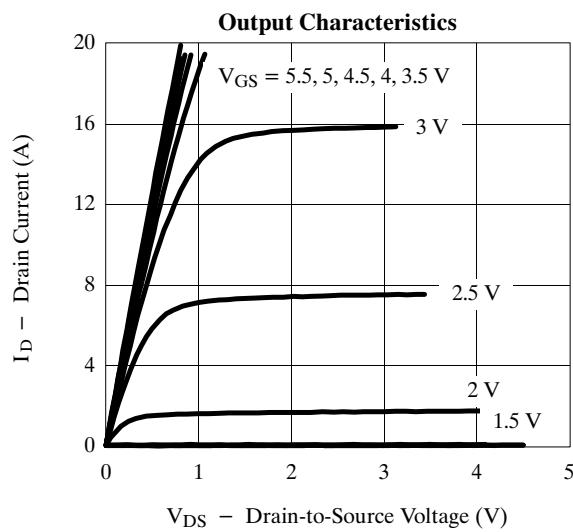
Subsequent updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #1227.

Specifications ($T_J = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typ ^a	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	0.8			V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}$		1		μA
		$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 70^\circ\text{C}$		5		
On-State Drain Current ^b	$I_{D(\text{on})}$	$V_{DS} \geq 5 \text{ V}, V_{GS} = 5 \text{ V}$	10			A
Drain-Source On-State Resistance ^b	$r_{DS(\text{on})}$	$V_{GS} = 7.2 \text{ V}, I_D = 5.0 \text{ A}$	0.025	0.036	0.045	Ω
		$V_{GS} = 4.5 \text{ V}, I_D = 5.0 \text{ A}$		0.041	0.05	
		$V_{GS} = 3.0 \text{ V}, I_D = 3.9 \text{ A}$		0.050	0.07	
		$V_{GS} = 2.5 \text{ V}, I_D = 1 \text{ A}$		0.060	0.08	
Forward Transconductance ^b	g_f	$V_{DS} = 10 \text{ V}, I_D = 5.0 \text{ A}$		13		S
Diode Forward Voltage ^b	V_{SD}	$I_S = 5.0 \text{ A}, V_{GS} = 0 \text{ V}$		0.9	1.2	V
Dynamic^a						
Total Gate Charge	Q_g	$V_{DS} = 6 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5.0 \text{ A}$		10	20	nC
Gate-Source Charge	Q_{gs}			2.6		
Gate-Drain Charge	Q_{gd}			3.7		
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = 6 \text{ V}, R_L = 6 \Omega$ $I_D \cong 1 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_G = 6 \Omega$		13	40	ns
Rise Time	t_r			9	30	
Turn-Off Delay Time	$t_{d(\text{off})}$			30	60	
Fall Time	t_f			9	30	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = 5.0 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$		100	150	

Notes

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.

Typical Characteristics (25°C Unless Otherwise Noted)

Typical Characteristics (25°C Unless Otherwise Noted)

